

# **Rotary Detection Sensor with Optical Reflection Type**

## **■FEATURES**

- Miniature, thin package: 2.6mm × 2.5mm × 0.8mm
- Digital two outputs type: A/ B phases
- Resolution 50.8LPI \* Lines Per Inch (2LPmm \* Lines Per mm)
- Recommendation strip width: 0.25mm
- Pb free soldering re-flowing permitted: 255°C, 2times
- Halogen free, Pb free
- Compliant with RoHS directive

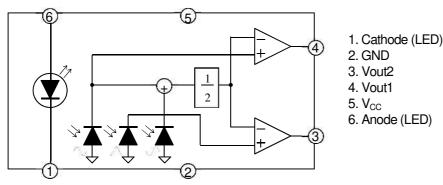
# ■APPLICATION

- Rotation detection of focus ring
- Rotation detection of the operation dial
- Rotation detection of the encoder plate

# ■ EQUIVALENT CIRCUIT BLOCK DIAGRAM

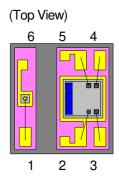
# ■GENERAL DESCRIPTION

NJL5820R is the compact surface mount type photo reflector, which is built in a high Brightness Infrared LED and PDIC. It can obtain two-phase(A,B) digital signals with the recommended striped reflector. It is the optimum sensor for various kinds of rotation detection, which can contribute to low power consumption of the set and simplification of the design.



#### ■ PIN CONFIGURATION

PIN No	NAME	FUNCTION
1	Cathode (LED)	Cathode for LED
2	GND	Ground
3	Vout2	Output Voltage 2
4	Vout1	Output Voltage 1
5	V <sub>CC</sub>	Power Supply
6	Anode (LED)	Anode for LED



#### **■ORDERING INFORMATION**

PART NUMBER	PACKAGE OUTLINE	RoHS	HALOGEN- FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ(pcs)
NJL5820R	COBP	yes	yes	Au	No marking	8.9	3,000

New Japan Radio Co., Ltd.

# ■ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT		
Emitter					
Forward Current (Continuous)	I <sub>F</sub>	30	mA		
Reverse Voltage (Continuous)	V <sub>R</sub>	6	V		
Power Dissipation	P <sub>D</sub>	45	mW		
Detector(PDIC)					
Supply Voltage	V <sub>CC</sub>	6.0	V		
Power Dissipation	P <sub>PDIC</sub>	5	mW		
Coupled					
Total Power Dissipation	P <sub>tot</sub>	50	mW		
Operating Temperature	T <sub>opr</sub>	-30 to +85	°C		
Storage Temperature	T <sub>stg</sub>	-40 to +100	°C		
Reflow Soldering Temperature	T <sub>sol</sub>	255	°C		

#### ■RECOMMENDATION OPERATING CONDITION

PARAMETER	SYMBOL	VALUE	UNIT
Forward current	I <sub>F</sub>	2 to 10	mA
Supply voltage	V <sub>CEO</sub>	+2.7 to +5.5	V
Distance between sensor and reflector	Gap	0.5 to 1.5	mm

# ■ELECTRO-OPTICAL CHARACTERISTICS (Ta=25°C)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Emitter						
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =5mA	1.1	1.4	1.7	V
Revers Voltage	I <sub>R</sub>	V <sub>R</sub> =6V	-	-	10	μA
Peak wavelength	$\lambda_{P}$		-	940	-	nm
Detector						
Supply Voltage	V <sub>CC</sub>		2.7	3.0	5.5	V
Operating Current	I <sub>CC</sub>	$V_{CC}=3V$ , In the dark	-	100	300	μA
Coupled						
Minimum Operating			1			mA
Current	I <sub>Fmin</sub>	V <sub>CC</sub> =3.0V,d=0.5mm	I	-	-	ША
High Level Output	V <sub>o</sub> H	V <sub>−</sub> H I <sub>F</sub> =2mA,V <sub>CC</sub> =3.0V,d=0.5mm	$V_{CC}-$	_	_	V
Voltage	VOLI	(reflector surface) * <sup>1</sup>	0.5	-	-	v
Low Level Output	V <sub>o</sub> L	I <sub>F</sub> =2mA,V <sub>CC</sub> =3.0V,d=0.5mm			GND	V
Voltage	vor	(non-reflector surface) *1	_	-	+ 0.5	v
Phase Difference of	of V <sub>P</sub> I <sub>F</sub> =2mA,V <sub>CC</sub> =3.0V,d=0.5mm -	_	90	-	dog	
output Voltage	۷P	$I_F=2mA,V_{CC}=3.0V,d=0.5mm$	-	90	-	deg.
Duty ratio	Duty	I <sub>F</sub> =2mA,V <sub>CC</sub> =3.0V,d=0.5mm	-	50	-	%
Rise Time	t <sub>r</sub>		-	0.1	-	µsec
Fall Time	t <sub>f</sub>		-	0.1	-	µsec

\*1: NJRC recommend the stripe reflector with 0.25mm strip and 0.25mm space.

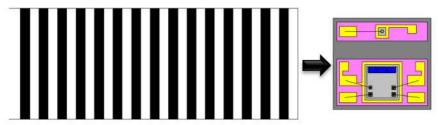
In the Electro-Optical characteristics table, items that are showed only the typical value are not tested in manufacturing process.

-*New Japan Radio Co.,Ltd.-*http://www.njr.co.jp/



## ■METHOD OF THE OUTPUT VOLTAGE MEASUREMENT

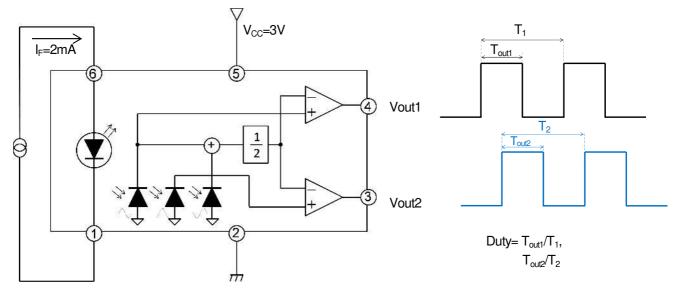
Output voltage measures with NJRC recommended mirror.



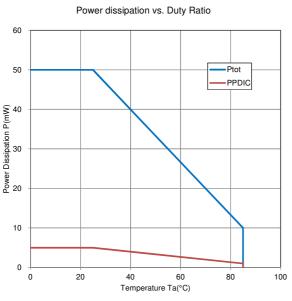
Strip mirror with PET film (0.25mm strip / 0.25mm space ) \* Meltec Co.,Ltd.



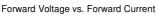
# ∎TEST CIRCUIT OF OUTPUT VOLTAGE

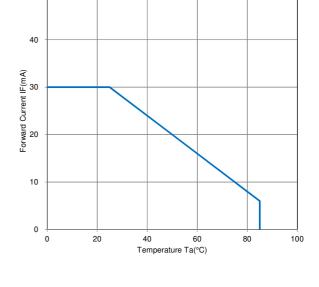








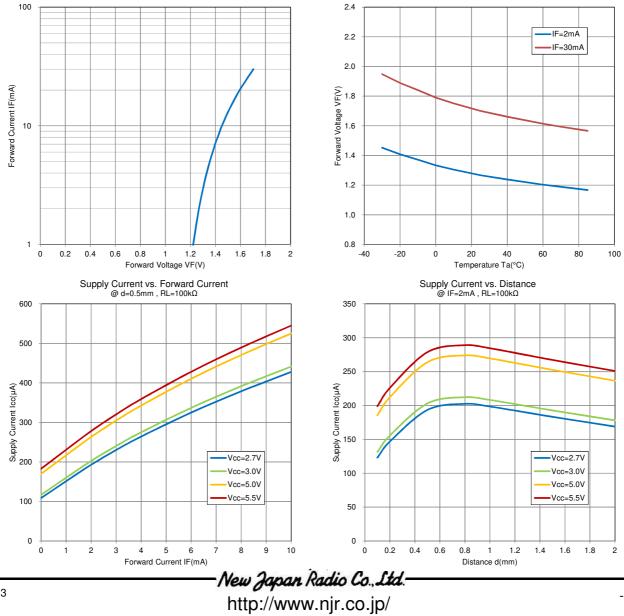




Forward Current vs. Temperature

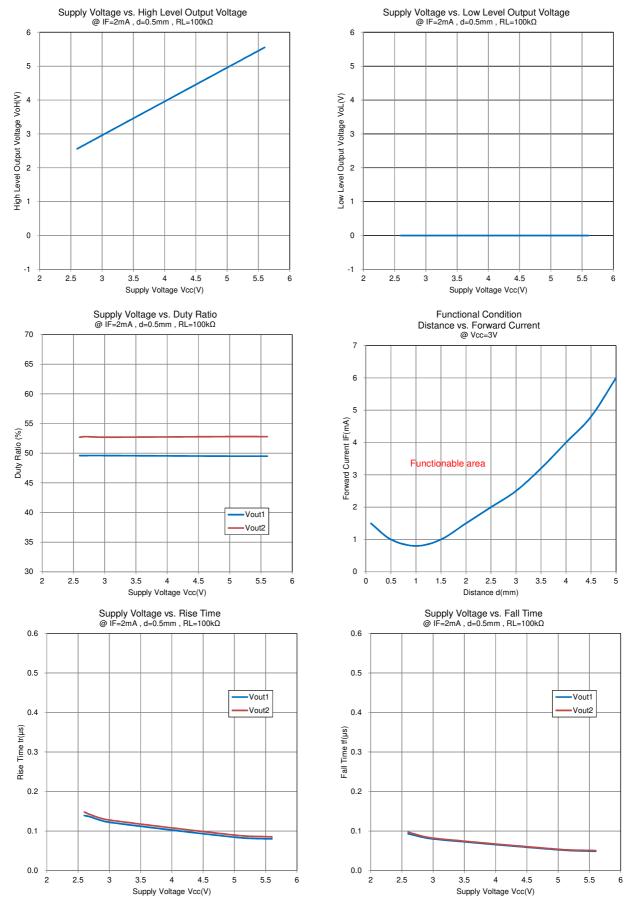
50







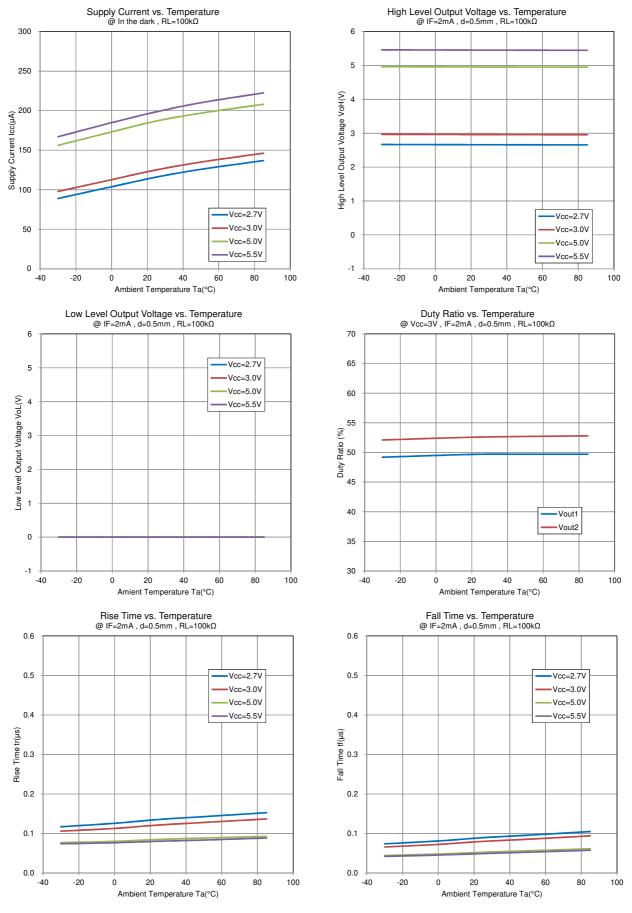
## ■TYPICAL CHARACTERISTICS (Ta=25°C)



-*New Japan Radio Co.,Ltd.* http://www.njr.co.jp/



# ■TYPICAL CHARACTERISTICS (Ta=25°C)





## ■APPLICATION NOTE

(1) Attention in handling

Treat not to touch the light receiving and light emitting part.

Avoid to adhering the dust and any other foreign materials on the light receiving and light emitting part when using.

When LED has operated by voltage, it should be connected the resistor of current adjustment. Avoid to applying direct voltage to LED, because there is possibility that LED is destroyed.

When mounting, special care has to be taken on the mounting position and tilting of the device because it is very important to place the device to the optimum position to the object.

#### (2) Attention in designing

Avoid the entering ambient light into light receiving part for avoid the malfunction by ambient light. Furthermore, there is possibility of malfunction when there are the other mounted parts by near this product peripheral.

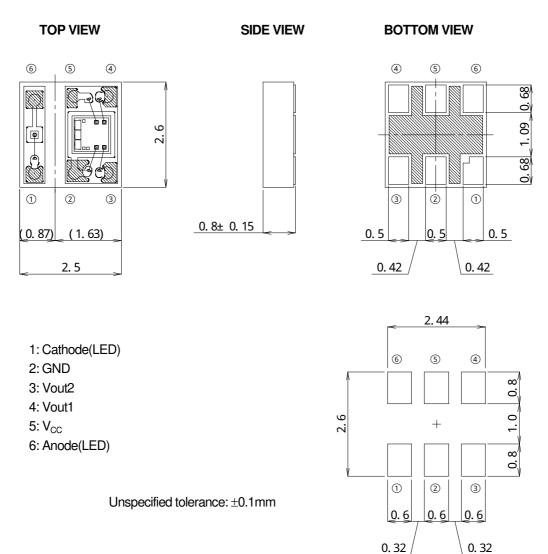
There will be changing characteristics by detection object. Refer to this datasheet and evaluate by actual detection object.

When LED has been applied continuous power on long period of time, the output current is dropped. If it uses by always applying power to LED, have to consider the circuit designing of including output current decrease.

New Japan Radio Co. Ltd.



# ■PACKAGE OUTLINE UNIT (mm)



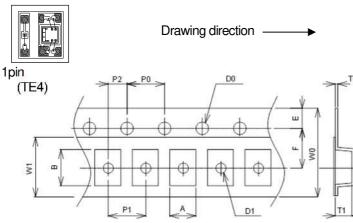
Foot Pattern

-*New Japan Radio Co., Ltd.-*http://www.njr.co.jp/



### ■PACKING SPECIFICATION

PACKING DIMENTIONS UNIT: mm Insert direction



DIMENSION	REMARK
2.85±0.10	BOTTOM DIMENNSION
2.95±0.10	BOTTOM DIMENNSION
ф1.50±0.10	
φ1.05±0.10	
1.75±0.10	
3.50±0.10	
4.00±0.10	
4.00±0.10	
2.00±0.10	
0.20±0.10	
1.20±0.10	
8.0+0.3/-0.1	
(5.5)	THICKNESS 0.1MAX.
	2.85±0.10 2.95±0.10 \$\$\phi1.50±0.10\$ 1.75±0.10 3.50±0.10 4.00±0.10 4.00±0.10 2.00±0.10 0.20±0.10 1.20±0.10 8.0 <sup>+0.3/-0.1</sup>

Carrier tape material: PC(Antistatic) Cover tape material: PETP(Antistatic)

#### **■TAPING STRENGTH**

There is a peel strength in the range of 0.2 to 0.7N when was peeled at a rate of 300mm per minute in opening angle 165 to 180° between the carrier tape and the cover tape.

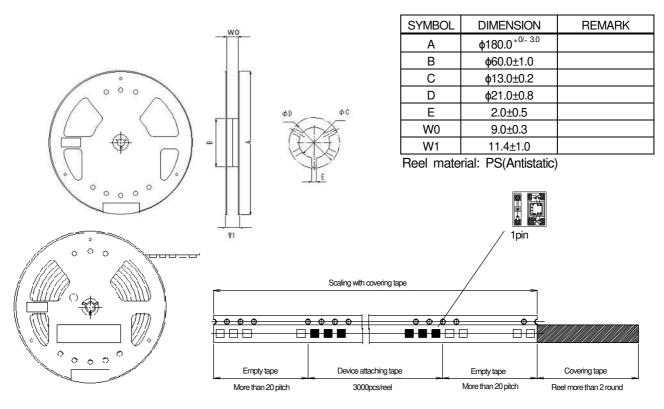
#### PACKAGING

1) The taped products are to be rolled up on the taping reel as on the drawing.

- 2) Rolling up specification
  - 2-1) Start rolling
  - 2-2) End of rolling
    - : Carrier tape open space more than 20 Pieces, and 2 round of reel space at the cover tape only.

: Carrier tape open space more than 20 Pieces.

- 3) Taping quantity : 3,000 Pieces
- 4) Seal off after putting each reels in a damp proof bag with silica gel.



New Japan Radio Co., Ltd.

# http://www.njr.co.jp/



#### ■RECOMMENDED MOUNTING METHOD

#### NOTE

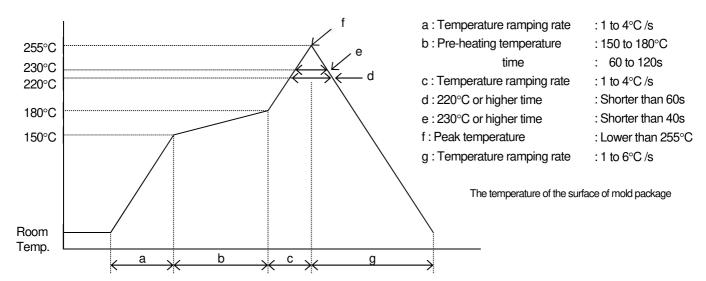
Mounting was evaluated with the following profiles in our company, so there was no problem. However, confirm mounting by the condition of your company beforehand.

The exposure of device under higher temperature many affect to the reliability of the products, it is recommended to complete soldering in the shortest time possible.

Mounting: Two Times soldering is allowed.

#### ■INFRARED REFLOW SOLDERING METHOD

Recommended reflow soldering procedure



(NOTE1) Using reflow furnace with short wave infrared radiation heater such as halogen lamp Regarding temperature profile, please refer to those fo reflow furnace. In this case the resin surface temperature may become higher than lead terminals due to en

In this case the resin surface temperature may become higher than lead terminals due to endothermic ally of black colored mold resin. Therefore, please avoid from direct exposure to mold resin.

#### (NOTE2) Other method

Such other methods of soldering as dipping the device into melted solder and vapor phase method (VPS) are not appropriate because the body of device will be heated rapidly. Therefore, these are not recommended to apply.

(NOTE3) The resin gets softened right after soldering, so, the following care has to be taken Not to contact the lens surface to anything. Not to dip the device into water or any solvents.

#### **■FLOE SOLDERING METHOD**

Flow soldering is not possible.

#### **■IRON SOLDERING METHOD**

Iron soldering is not possible.

New Japan Radio Co., Ltd.



#### **■CLEANING**

Avid washing the device after soldering by reflow method.

#### **■IC STORAGE CONDITIONS AND ITS DURATION**

(1) Temperature and humidity ranges

Pack Sealing	Temperature:	5 to 40 [°C]
	Humidity:	40 to 80 [%]
Pack Opening	Temperature:	5 to 30 [°C]
	Humidity:	40 to 70 [%]

After opening the bag, solder products within 48h.

Avoid a dry environment below 40% because the products are is easily damageable by the electrical discharge. Store the products in the place where it does not create dew with the products due to a sudden change in temperature.

- (2) When baking, place the reel vertically to avoid load to the side.
- (3) Do not store the devices in corrosive-gas atmosphere.
- (4) Do not store the devices in a dusty place.
- (5) Do not expose the devices to direct rays of the sun.
- (6) Do not allow external forces or loads to be applied to IC's.
- (7) Be careful because affixed label on the reel might be peeled off when baking.
- (8) The product is recommended to do the baking before using for the stability of the quality.

#### BAKING

In case of keeping expect above condition be sure to apply baking. Baking method: Ta=60°C, 48 to 72h, One time baking is allowed

#### **■STORAGE DURATION**

Within a year after delivering this device. For the products stored longer than a year, confirm their terminals and solderability before they are used.

#### ■MOISTURE SENSITIVITY LEVELS

JEDEC : Level 5

New Japan Radio Co., Ltd.-http://www.njr.co.jp/



# [CAUTION]

 New JRC strives to produce reliable and high quality semiconductors. New JRC's semiconductors are intended for specific applications and require proper maintenance and handling. To enhance the performance and service of New JRC's semiconductors, the devices, machinery or equipment into which they are integrated should undergo preventative maintenance and inspection at regularly scheduled intervals. Failure to properly maintain equipment and machinery incorporating these products can result in catastrophic system failures

2. The specifications on this datasheet are only given for information without any guarantee as regards either mistakes or omissions. The application circuits in this datasheet are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights. All other trademarks mentioned herein are property of their respective companies.

- 3. To ensure the highest levels of reliability, New JRC products must always be properly handled. The introduction of external contaminants (e.g. dust, oil or cosmetics) can result in failures of semiconductor products.
- 4. New JRC offers a variety of semiconductor products intended for particular applications. It is important that you select the proper component for your intended application. You may contact New JRC's Sale's Office if you are uncertain about the products listed in this catalog.
- 5. Special care is required in designing devices, machinery or equipment which demand high levels of reliability. This is particularly important when designing critical components or systems whose failure can foreseeably result in situations that could adversely affect health or safety. In designing such critical devices, equipment or machinery, careful consideration should be given to amongst other things, their safety design, fail-safe design, back-up and redundancy systems, and diffusion design.
- 6. The products listed in the catalog may not be appropriate for use in certain equipment where reliability is critical or where the products may be subjected to extreme conditions. You should consult our sales office before using the products in any of the following types of equipment.

Aerospace Equipment Equipment Used in the Deep Sea Power Generator Control Equipment (Nuclear, Steam, Hydraulic) Life Maintenance Medical Equipment Fire Alarm/Intruder Detector Vehicle Control Equipment (airplane, railroad, ship, etc.) Various Safety devices

- 7. New JRC's products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this catalog. Failure to employ New JRC products in the proper applications can lead to deterioration, destruction or failure of the products. New JRC shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of its products. Products are sold without warranty of any kind, either express or implied, including but not limited to any implied warranty of merchantability or fitness for a particular purpose.
- 8. Warning for handling Gallium and Arsenic (GaAs) Products (Applying to GaAs MMIC, Photo Reflector). This Products uses Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed, please follow the related regulation and do not mix this with general industrial waste or household waste.
- 9. The product specifications and descriptions listed in this catalog are subject to change at any time, without notice.



New Japan Radio Co., Ltd.

http://www.njr.co.jp/